

## N-Channel 30 V (D-S) MOSFET

Top View

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Typ.	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
30	0.004 at V <sub>GS</sub> = 4.5 V	50	33.5 nC			
30	0.005 at V <sub>GS</sub> = 2.5 V	45	33.3 110			

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

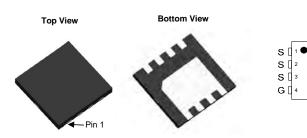
- Motor Control
- Industrial
- Load Switch
- ORing

8 D

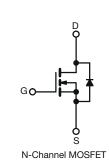
7 D

6 D

5 D



DFN 3x3 EP



<b>ABSOLUTE MAXIMUM RATIN</b>	<b>IGS</b> (T <sub>A</sub> = 25 °C	, unless othe	erwise noted)		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$\begin{array}{c} T_{C} = 25 \ ^{\circ}C \\ \hline T_{C} = 70 \ ^{\circ}C \\ \hline T_{A} = 25 \ ^{\circ}C \\ \hline T_{A} = 70 \ ^{\circ}C \end{array}$	I <sub>D</sub>	50 <sup>a, e</sup> 40 <sup>a, e</sup> 22 <sup>b, c</sup> 15 <sup>b, c</sup>		
Pulsed Drain Current (t = 300 µs)		I <sub>DM</sub>	150	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	- I <sub>S</sub>	35 3.3 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	20		
Single Pulse Avalanche Energy	Je Pulse Avalanche Energy L = 0.1 mH		20	mJ	
Maximum Power Dissipation $T_{C}$ : $T_{C}$ : $T_{A}$ : $T_{A}$ :		P <sub>D</sub>	52 33 3.7 <sup>b, c</sup> 2.4 <sup>b, c</sup>	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Tempera	ature)		260		

#### THEDMAL RESISTANCE BATINGS

I HERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	24	33	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	1.9	2.4	0/11	

Notes:

a. Based on  $T_C = 25 \text{ °C}$ . b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 90 °C/W. e. Calculated based on maximum junction temperature. Package limitation current is 80 A.



<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C	<u>г</u>		N.4.1	<b>T</b>	Marr	11	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	1					r	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$ V, $I_D = 250$ $\mu$ A	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		30		mV/°0	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 5.6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.5		1.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0$ V, $V_{GS} = \pm 20$ V			± 100	nA	
Zero Gate Voltage Drain Current	Inco	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
Zero Gale voltage Drain Current	IDSS	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	30			Α	
Ducin Course On Otate Desistance	В	V <sub>GS</sub> =4.5 V, I <sub>D</sub> = 10 A 0		0.0040			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		0.0050		Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		65		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			3065		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz		406			
Reverse Transfer Capacitance	C <sub>rss</sub>			360			
<b>T</b> :		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		68	102	- nC	
Total Gate Charge	Qg			33.5	51		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		7.7			
Gate-Drain Charge	Q <sub>gd</sub>			13.8			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.3	0.7	1.4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			24	45		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		24	45	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10$ Å, $V_{GEN} = 4.5$ V, $R_g = 1$ $\Omega$		32	60		
Fall Time	t <sub>f</sub>	-		12	24		
Turn-On Delay Time	t <sub>d(on)</sub>			14	28	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_{I}$ = 1.5 $\Omega$		13	26	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		33	60		
Fall Time	t <sub>f</sub>	-		8	16		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C		35			
Pulse Diode Forward Current	I <sub>SM</sub>	-		70		A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		0.7	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			21	40	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			10	20	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F$ = 10 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C		9			
Reverse Recovery Rise Time	t <sub>b</sub>			12		ns	

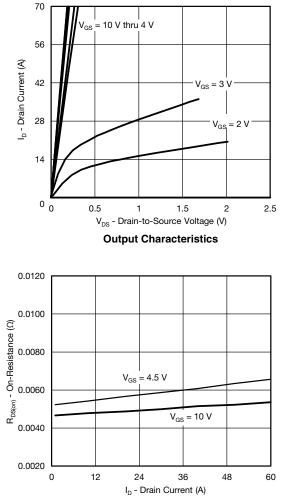
Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

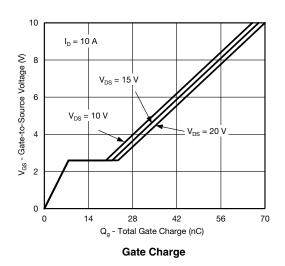
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

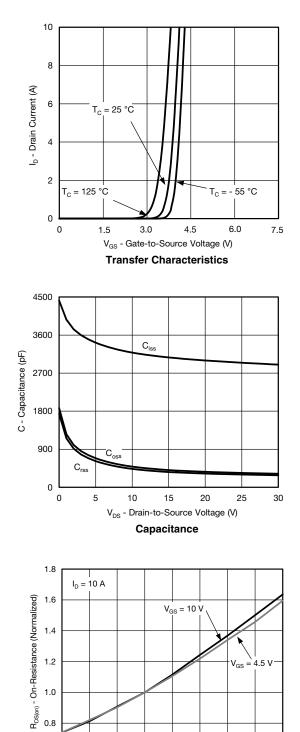
emi

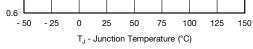




**On-Resistance vs. Drain Current and Gate Voltage** 

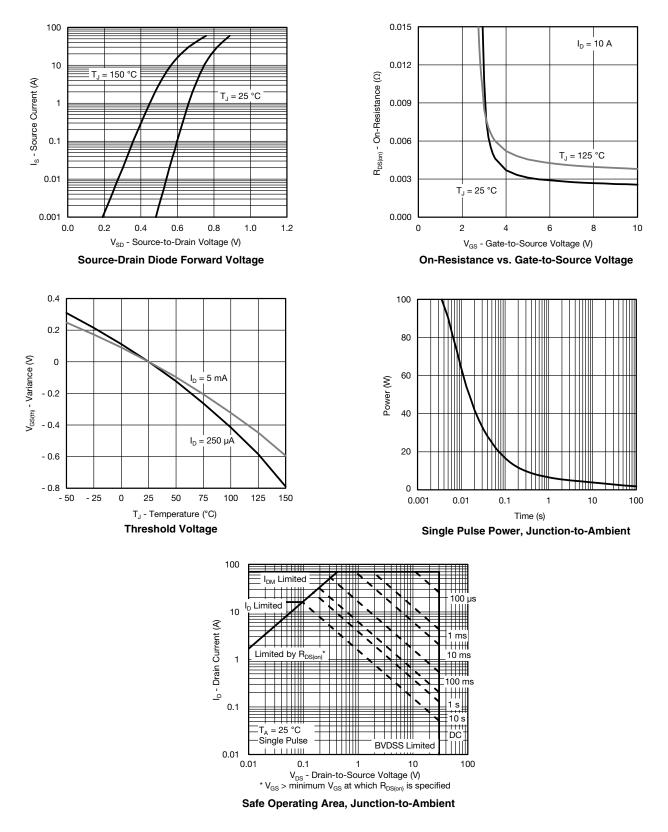




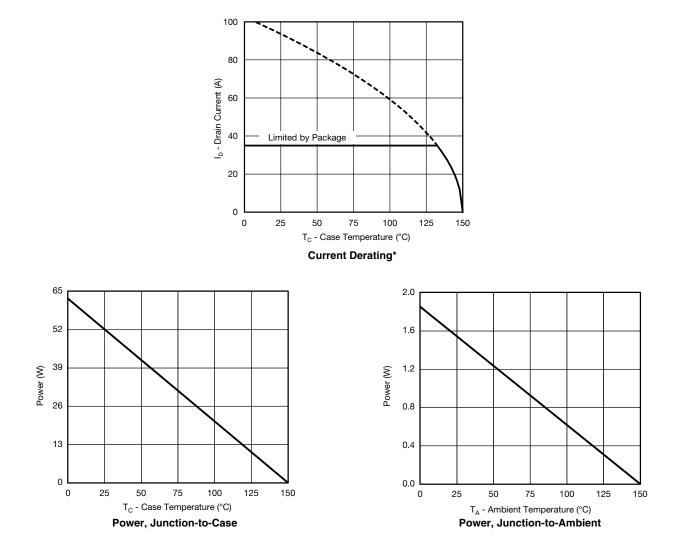


**On-Resistance vs. Junction Temperature** 



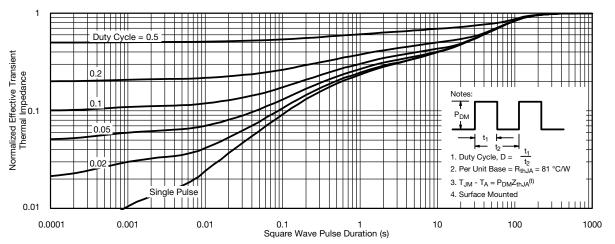




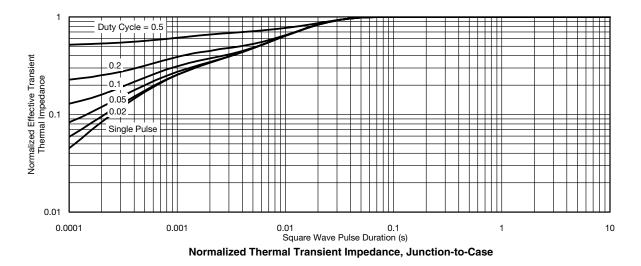


\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

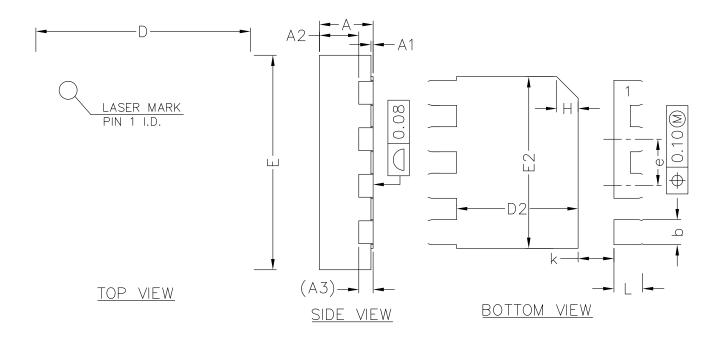














<u>SIDE VIEW</u>

SYMBOL	MIN	NOM	MAX	
А	0.70	0.75	0.80	
A1	0.00	0.02	0.05	
A2	0.50	0.55	0.60	
A3	0.20REF			
b	0.30	0.35	0.40	
D	2.90	3.00	3.10	
E	2.90	3.00	3.10	
D2	1.60	1.70	1.80	
E2	2.30	2.40	2.50	
е	0.55	0.65	0.75	
K	0.40	0.50	0.60	
	0.35	0.40	0.45	

### COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)



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